

Thrubeam Digital Laser Sensor with the Highest Level of Stability



REPEATABILITY OF 5 μm 0.20 Mil LINEARITY OF ± 0.1% (IG-028)

The sensor provides a high level of stability with its multi-wavelength laser and parallel computing chip.

WIDE VARIETY OF APPLICATION MODES

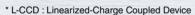
- Edge control mode
- Outer diameter measurement mode
- Inner diameter/Gap measurement mode
- Edge detection of transparent targets



IG-028: Max. 1500 mm 59.06" IG-010: Max. 1000 mm 39.37"

L-CCD* Light-Receiving Element

The sensor recognizes the position of a target and is less sensitive to its environment, making it possible to achieve stable target measurement.





IP67 Protection

The enclosure is resistant to harsh environments and offers long-term durability.

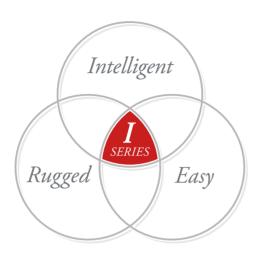
Display Unit Options

There are two types of display units: panel mount and DIN-rail mount. When a display unit is connected to a communication unit, measurement data can be sent to external devices such as a PLC.



Intelligent sensor SERIES

THREE CONCEPTS



Intelligent

High accuracy was achieved by using the technology and functions developed for high-accuracy measuring instruments.

Rugged

Developed for use in harsh environments, the IG Series was designed with a strong structure.

Easy

Excellent usability makes it possible to quickly and easily perform stable measurements without any difficult adjustments and settings.

The intelligent I-Series consists of a high-accuracy sensor lineup that realizes low-cost high performance with only the most advanced functions for on-site operations.





High stability and measurement accuracy are achieved with the newly developed optical system

Multi-Wavelength Laser + I-DSP

With conventional lasers, the transmission spot produces a patchy pattern (as shown in the figure to the right). This is a laser-specific interference problem caused by the laser having a single wavelength. The IG Series sensor overcomes this problem by using a multi-wavelength laser. Because shadows are formed on the CCD more clearly, the sensor remains highly

stable, even with targets that are conventionally difficult to detect (e.g. transparent objects). With the I-DSP (a parallel computing chip) incorporated in the receiver, the sensor can perform data processing at high speed, reducing noise to a minimum.



Best in its class

SPOT IMAGE

Single-wavelength laser (conventional laser sensor)

A patchy pattern appears.

Multi-wavelength laser (IG)

Due to the multi-wavelength laser used, the beam pattern has a more uniform intensity distribution.

Best in its class

Repeatability of 5 µm 0.20 Mil

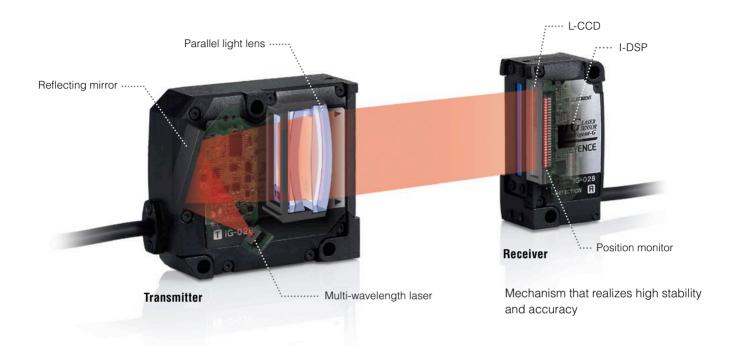
Linearity of ±0.1%

STABLE DETECTION OF TRANSPARENT & MESH TARGETS

The L-CCD makes it possible to detect a target based on its position. Edge control and positioning of transparent and mesh targets can be performed stably.









Extremely easy to use due to the built-in position monitor

Determining the Part of a Target to be Measured

The position monitor on the IG Series sensors makes it possible to visually check how a target is detected. The user can prevent mounting or setting errors by observing the red lights that indicate the received light position and the green lights that indicate the measurement position.



Easier Optical Axis Alignment

The position monitor makes it easier to align the optical axis. Easily perform optical axis alignment by adjusting the sensor head so that all of the position monitor lights turn red.

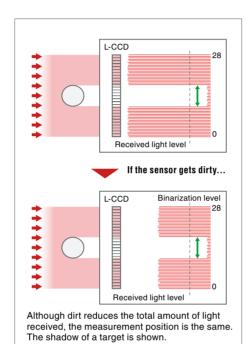


function and structure that matches the on-site environment



Easy to maintain thanks to excellent environment resistance

Key Point: Less Sensitive to Dirt



Because it uses an L-CCD, the IG Series is less sensitive to materials such as dirt than a sensor that uses a photodiode (PD) as the light-receiving element.

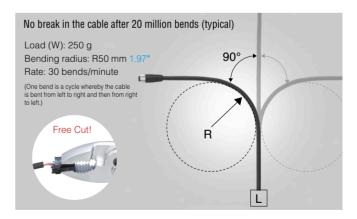
IP67 Protection

The enclosure satisfies the IP67 rating based on the IEC standards and remains watertight even after being held at a depth of one meter for 30 minutes. The enclosure is resistant to adverse environments and offers long-term durability.



Flexible Free-Cut Cable

The sensor head cable is a robot cable that withstands repeated bending. The cable can be used safely in a position requiring repeated motion.



Edge Check Function

The user can check whether a measurement is performed correctly by verifying the number of edges in the field of view.

Example

- Prevent dust or oil from adhering to the measurement unit, which can cause an abnormal measurement value.
- Detect the intrusion of a different type of target.
- Check that a measurement target falls within the measurement range.

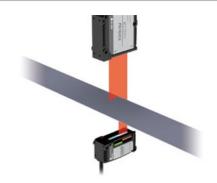
EASY SETTING WITH THE APPLICATION MODES

Three major application modes

The measurement area is automatically specified simply by selecting the mode.

Edge Control and Positioning Mode

The distance from the end of the measurement range to the edge of a target is measured.

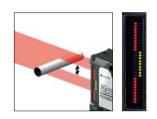




Outer Diameter/ Width Measurement Mode

The outer diameter or width of a target is measured.

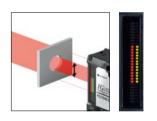




Inner Diameter/ Gap Measurement Mode

The inner diameter of a target or a gap between targets is measured.

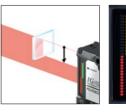


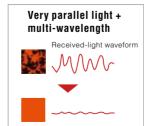


Five dedicated modes can be selected according to the application

Edge Detection of Transparent Targets

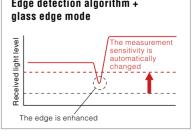
The edges of transparent objects such as glass have low transparency which decreases the amount of light received. The IG Series detects edges exploiting this nature and automatically changes a measurement sensitivity appropriately to detect a transparent target.





Edge detection algorithm + glass edge mode

Edge detection algorithm +







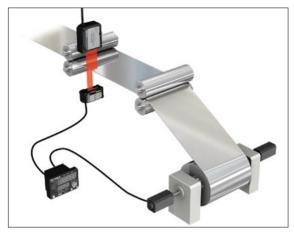




Specified edge-to-edge distance measurement mode

BUILT-IN CALCULATION FUNCTIONS ALLOW FOR AN EVEN WIDER VARIETY OF APPLICATIONS

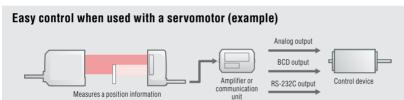
Edge Control and Positioning Mode + Control output



Feedback control using edge position control

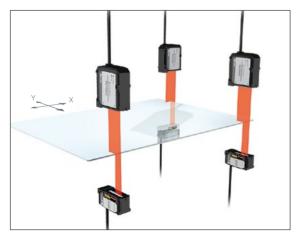


Positioning control of the θ angle of a wafer

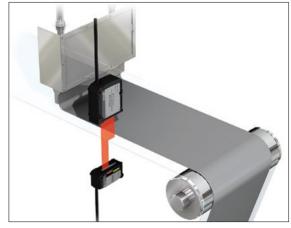


Outputs the edge position information to a control device. It is possible to send the information via an analog output, BCD output, or RS-232C output according to the type of the control device instead of using a PLC.

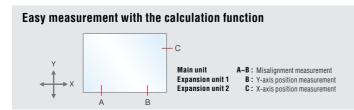
Glass Edge Mode + Calculation function



Positioning of a glass substrate

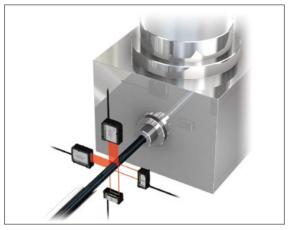


Edge control of a transparent sheet

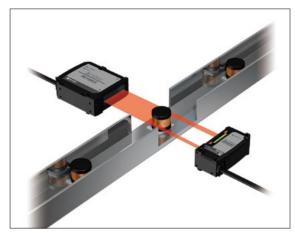


The main unit of the amplifier can communicate with the expansion units. When positioning an object such as a panel, it is possible to calculate a misalignment amount by calculating the data obtained by two sensor heads.

Outer Diameter/Width Measurement Mode + Calculation function

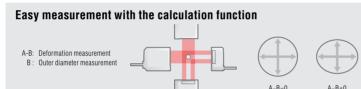


Outer diameter/deformation measurement an extrudate



Outer diameter measurement of a part



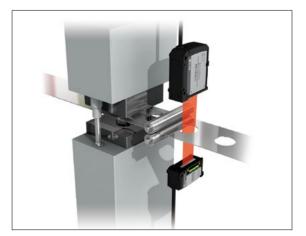


Abnormal diameters and deformations can be detected in real time by measuring a tube at two axes. The 980 µs high-speed sampling detects even tiny abnormalities.

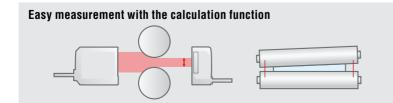
Inner Diameter/Gap Measurement Mode + Calculation function



Gap measurement between rollers



Diameter check of press cutting



The thickness of a product can be controlled by measuring the gaps of the two sides between the rollers.

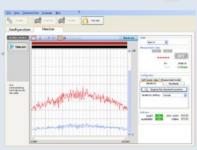
EVEN MORE USEFUL WHEN CONNECTED TO A PC

The configuration software, IG Configurator, allows for a wide range of settings to be made including the monitoring of the waveforms of received light and the measurement modes.



Monitoring Function

Measurement conditions such as the waveforms of received light can be displayed in real time. The mounting and sensitivity settings can also be adjusted more precisely.

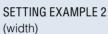


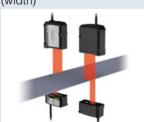
Calculation Function

Addition mode (if a measurement target is large)

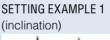
(length)

SETTING EXAMPLE 1



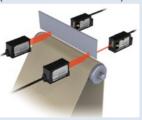


Subtraction mode (to measure the difference in level or inclination)





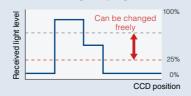
SETTING EXAMPLE 2 (difference in thickness)



Sensitivity Setting

The set value used to judge whether light enters or is blocked, based on the amount of light received by the CCD, is called the binarization level. The amount of light received when the reference waveform is registered is regarded as the 100% level. The light is judged

to be blocked if the amount of light is less than the specified binarization level. The IG Series initially sets a binarization level of 25% and the user can change the level according to the application.



Zero Shift Function

This function shifts an internal measurement value to 0 (to offset the value). When the target value is changed, this function can be used to shift an internal measurement value to the new target value.

DATA COMMUNICATION

Amplifier Function

NPN/PNP Output Selection (judgment selection)

Both NPN and PNP outputs are supported. The outputs are set the first time the user turns on the power. These settings can subsequently be changed. Judgments are output as HIGH, GO, or LOW.

Bank Function

The bank function can register up to four patterns of specific settings.* For example, in response to a measurement target changeover, this function allows the user to easily switch between the patterns of registered settings.

Analog Output Selection

The following four types of analog outputs can be selected.

The output is selected the first time the user turns on the power.

Setting value	Description
oFF	Not output
0-Su	Analog output after the judgment value is converted to the range from 0 to 5 V.
-5-50	Analog output after the judgment value is converted to the range of ±5 V.
1-50	Analog output after the judgment value is converted to the range from 1 to 5 V.
8525	Analog output after the judgment value is converted to the range from 4 to 20 mA.

The setting can be changed.

Communication Unit

Open field network communication units

Achieving great wire-saving with the new open field network communication units

DL Series

Model	Appearance	Communication method	Connection device
NEW DL-EC1A		EtherCAT [®]	PLCs
DL-PN1		PROFINET	PLCs
DL-EP1		EtherNet/IP™	PLCs
DL-DN1		DeviceNet [™]	PLCs

Model	Appearance	Communication method	Connection device
DL-PD1		PROFIBUS	PLCs
NEW DL-EN1		TCP/IP	PLCs Computers
DL-R\$1A		RS-232C	PLCs Computers
DL-RB1A		BCD-Output	PLCs Computers

EtherCAT® is registered trademark and patented technology, licensed by Beckhoff Automation GmbH, Germany.

Lineup

Sensor heads

IG-010



Measurement range Mounting distance Repetition accuracy

Linearity

10 mm 0.39" 0 to 1000 mm 39.37" 5 µm 0.20 Mil ⁻¹ (Setting distance: 100 mm 3.94") ±28 µm ±1.10 Mil ⁻¹



Measurement range Mounting distance Repetition accuracy

28 mm 1.10" 0 to 1500 mm 59.06" 5 µm 0.20 Mil '1 (Setting distance: 100 mm 3.94") ±28 µm ±1.10 Mil '1

*1 For the detailed conditions, refer to "Specifications" (page 12)

Display units (amplifiers)





Panel mount type IG-1500

Main unit



IG-1550 Expansion unit

Linearity



Sensor head cables

Appearance	Cable length	Model	Weight
	2 m 6.56' *2	OP-87056	Approx. 80 g
	5 m 16.40'	OP-87057	Approx. 190 g
*	10 m 32.80'	OP-87058	Approx. 360 g
	20 m 65.62'	OP-87059	Approx. 680 g

The cable is common to the transmitter and receiver, and can be used with either of them

This connector is required if the cable is cut.



Connector used to connect to a display unit (2 pcs.)

^{*} HIGH setting value, LOW setting value, binarization level, shift target value, etc.

^{*2} Two cables are included with a sensor head

Optional

	Туре	Model	Appearance	Description	Weight
PC software ⁻¹	IG Configurator	IG-H1		-	Approx. 80 g
Sensor head	For IG-010	IG-TB01		-	Approx. 50 g
mounting brackets ⁻² For IG-028	For IG-028	IG-TB02		-	Approx. 40 g
	End unit (Optional)	OP-26751	Sept and	To connect an additional expansion unit, use the end units to secure the display units on both ends. When connecting additional units, be sure to use the end units. (2 pcs.)	Approx. 15 g
Optional accessories for the display unit	Panel front protection cover [Included in panel mount type amplifier]	OP-87076		The panel front protection cover and panel mounting bracket are included in the panel mount type amplifier. If the supplied cover or bracket is lost or damaged.	Approx. 6 g
	Panel mounting bracket [Included in panel mount type amplifier]	OP-4122	O	purchase a new one.	Approx. 7 g
				Extension cable used for panel mount type amplifier. Use this cable if the standard 50 mm 1.97° cable is not long enough.	
Optional accessories for the communication unit	Expansion cable: 300 mm 11.81"	OP-35361		Although the DL Series is designed for the DIN-rail mount type only, the optional expansion cable (OP-35361, 300 mm 11.81') enables communication with the panel mount type display unit.	Approx. 10 g
	DIN-rail mounting bracket	OP-60412		The mounting bracket is used when the expansion cable is used to connect to the panel mount type display unit, in which case a DIN rail is not provided.	Approx. 12 g

Specifications

Sensor heads

CCD method			
Visible light semiconductor laser (Wavelength:660 nm)			
Class 1 Laser Product*			
IEC60825-1 Class 1 Laser Product			
Mounting distance 0 to 1000 mm 39.37° 0 to 1500 mm 59.06° Measurement range 10 mm 0.39° 28 mm 1.10° Sampling cycle 980µs (When the number of times for averaging is set to [hsp]: 490µs) Minimum detectable object *² #Igh sensitivity mode Ø0.1 mm @0.003° (Setting distance: 100 mm 3.94°) Standard mode 90.2 mm @0.007° (Setting distance: 40 mm 1.57°), @0.2 mm @0.007° (Setting distance: 500 mm 19.68°) Ø0.5 mm @0.02° (Setting distance: 500 mm 19.68°)			
Measurement range 10 mm 0.39° 28 mm 1.10°			
Sampling cycle 980µs (When the number of times for averaging is set to [hsp]: 490µs) Minimum detectable object *2 Minimum detectable object *2 80.2 mm @0.007" (Setting distance: 40 mm 1.57"),			
Minimum detectable object *2 Blandard mode # ### ### ### ### ### ### ### ### ###			
Minimum detectable object *2 Standard mode o0.2 mm ø0.007" (Setting distance: 40 mm 1.57"), ø0.5 mm ø0.02" (Setting distance: 500 mm 19.68") sum ø0.02" (Setting distance: 500 mm 19.68") 5 µm 0.20 Mil (Setting distance: 100 mm 2.04") 5 µm 0.20 Mil (Setting distance: 100 mm 2.04")			
object *2 Standard mode 60.2 mm 60.007* (Setting distance: 40 mm 1.5/7). 60.2 mm 60.007* (Setting distance: 50 mm 19.68*) 60.5 mm 60.02* (Setting distance: 500 mm 19.68*) 60.5 mm 60.02* (Setting distance: 500 mm 19.68*) 5 mm 60.02* (Setting distance: 100 mm 20.41*) 5 mm 60.02* (Setting distance: 100 mm 20.41*)			
	m 19.68")		
Repeatability *3 10 µm 0.39 Mil (Setting distance: 100 mm 19.68°) 10 µm 0.39 Mil (Setting distance: 500 mm 19.68°) 80 µm 3.15 Mil (Setting distance: 1000 mm 39.37°) 10 µm 0.39 Mil (Setting distance: 1000 mm 19.68°) 10 µm 0.39 Mil (Setting distanc	m 19.68́") ım 39.37")		
Linearity *4 ±0.28 % of F.S. (±28 µm ±1.10 Mil) ±0.1 % of F.S. (±28 µm ±1.10 Mil))		
Temperature characteristics *5 ±0.03 % of F.S./°C (±3 µm ±0.12 Mil/°C) ±0.01 % of F.S./°C (±3 µm ±0.12 Mil	/°C)		
Operation Transmitter Optical axis alignment indicator: Green LED Power indicator: Green LED	Power indicator: Green LED		
Receiver Optical axis alignment indicator: Green LED Position monitor: Dual bar LED (Red, Green)			
Enclosure rating IP67			
Ambient temperature -10 to +45°C 14 to 113F° (No freezing)			
Environment Ambient humidity 35 to 85% RH (No condensation)			
resistance Ambient light *5 Incandescent lamp: 5000 lux Sunlight: 5000 lux			
Vibration resistance 10 to 55 Hz Double amplitude 1.5 mm 0.06° XYZ each axis: 2 hours			
Pollution degree 2			
Zinc die-cast (Lower case), PBT (Upper case), Polyarylate (PAR) (Display part), SUS304 (Metallic part)			
Material Lens cover Glass			
Cable PVC			
Supplied item Transmitter x 1, Receiver x 1, Sensor head cables (2 m 0.08") x 2			
Weight (including supplied items) Approx. 380 g Approx. 500 g			

^{*1} The DL-RS1A communication unit is required.
*2 The screws for connecting the sensor head and bracket are included.

^{**}T1 The classification for FDA (CDRH) is implemented based on IEC60825-1 in accordance with the requirements of Laser Notice No.50.

**2 When the measurement target object is measured at the center position of the setting distance.

When the measurement mode is set to the glass edge mode, a glass edge of C0.1 mm 0.003° or more can be detected (Setting distance: 500 mm 19.69°).

**3 When the light is shielded by half at the center position of the setting distance with when the average number of times is set to 16 and sampling is performed for 30 seconds. (When the analog output is used, the margin of error of analog output is added.)

**4 When the setting distance is 100 mm 3.94° and light is shielded at 50 mm 1.96° position from the receiver. Margin of error to the ideal line.

**5 When the setting distance is 100 mm 3.94° and light is shielded by half at 50 mm 1.96° position from the receiver.

**6 Excluding when the average number of times is set to [hsp].

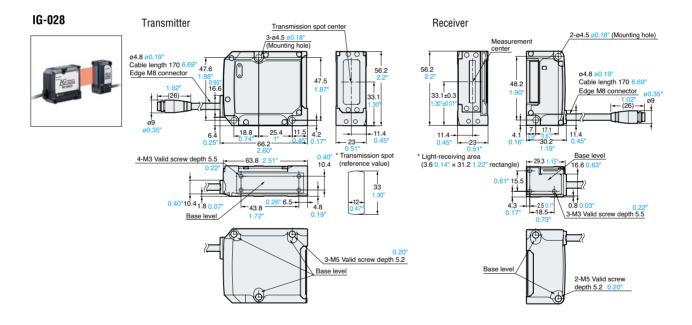
Display unit (amplifier)

Model		IG-1000	IG-1050	IG-1500	IG-1550
Appearance				2800	2800
Amplifier type		DIN rail mou	int	Panel mount	
Main unit/Expansion unit		Main unit	Expansion unit	Main unit	Expansion unit
Analog output		Yes	No	Yes	No
Power supply voltage		•	10-30 VDC, Ripple (P-P): 10	% included, Class 2 or LPS	5
ower consumption	Normal	2700 mW or less (at 30 V	: 90 mA or less)	2880 mW or	less (at 30 V: 96 mA or less)
including analog current	Power saving function (HALF)		2300 mW (at 30		
utput)	Power saving function (ALL)	2200 mW (at 30 V: 74 mA or less)			
Digital display method		Dual 7-seg dis Upper level: Red, Lower level: Green	5 digits	Upper level: F	ual 7-seg display Red/Green, 2 colors, 5 digits · level: Green, 5 digits
Display range			to +99.999, -99.99 to +99.99,	<u>'</u>	· /
Display resolution		<u>'</u>	Mil, 10 μm 0.39Mil, 100 μm 3		<u>'</u>
	Judgment output (selectable between NPN and PNP)	NPN (PNP) open collec	tor x3ch, 30 VDC (Power supp N.O./N.C. selectable		Il voltage 1 V (2 V) or less,
	Response time (judgment output)	1.96 to 4031.72 ms *2			
	Edge check output (selectable between NPN and PNP)	NPN (PNP) open collector x1ch, 30 VDC (Power supply voltage) or less, residual voltage 1 V (2 V) or less, N.O./N.C. selectable Max. 50 mA, *1 response time 20 ms			
			Voltage or	itput	Current output
		Output range	±5 V (full sca	le 10 V) 4-2	20 mA (full scale 16 mA)
utput	A-classical	Output resistance	100 Ω		
		Maximum load resistance	-	555 11	
	Analog output (selectable among ±5V, 1-5 V, 0-5 V,	Repetition accuracy	±1 mV		±1.5 μA
	4-20 mA)	Display accuracy		±0.05 % of F.S. ±0.25 % of F.S.	
		Temperature characteristics		±0.005 % of F.S./°C ±0.01% of F.S./°C	
		Update cycle	Same as sensor head sampling cycle		• •
		Response time	Sam	Same as Response time (judgment output)	
		T'			. ,
		Time constant *3	10 µs (90 % ге	esponse) 3	80 μs (90 % response)
	Gain input	Input time: 20 ms or more	10 µs (90 % re e, Response delay time: 120 m	sponse) 3 s or less (Nonvolatile mem	lo µs (90 % response) nory (EEPROM) 1.5 s or less)
	Reset input	Input time: 20 ms or more	10 µs (90 % re s, Response delay time: 120 m put time: 20 ms or more, Res	esponse) 3 s or less (Nonvolatile mem ponse delay time: 20 ms or	ory (EEPROM) 1.5 s or less) less
nput	Reset input Timing input	Input time: 20 ms or more In	10 µs (90 % re e, Response delay time: 120 m put time: 20 ms or more, Res nput time: 2 ms or more, Res	esponse) 3 s or less (Nonvolatile mem ponse delay time: 20 ms or ponse delay time: 2 ms or l	10 μs (90 % response) Hory (EEPROM) 1.5 s or less) Hess Hess
nput	Reset input Timing input Zero shift input	Input time: 20 ms or more In In	10 µs (90 % re e, Response delay time: 120 m put time: 20 ms or more, Res nput time: 2 ms or more, Res put time: 20 ms or more, Res	esponse) 3 s or less (Nonvolatile mem ponse delay time: 20 ms or ponse delay time: 2 ms or l ponse delay time: 20 ms or	00 µs (90 % response) ory (EEPROM) 1.5 s or less) less ess less
nput	Reset input Timing input Zero shift input Bank A input/Bank B input	Input time: 20 ms or more In In In	10 µs (90 % re e, Response delay time: 120 m put time: 20 ms or more, Res nput time: 2 ms or more, Res put time: 20 ms or more, Res ut time: 20 ms or more, Resp	sponse) 3 s or less (Nonvolatile mem ponse delay time: 20 ms or ponse delay time: 2 ms or l ponse delay time: 20 ms or onse delay time: 20 ms or l	00 µs (90 % response) ory (EEPROM) 1.5 s or less) less ess less ess *2
nput	Reset input Timing input Zero shift input Bank A input/Bank B input Laser emission stop input	Input time: 20 ms or more In In In	10 µs (90 % re e, Response delay time: 120 m put time: 20 ms or more, Res nput time: 2 ms or more, Res put time: 20 ms or more, Res ut time: 20 ms or more, Res nput time: 2 ms or more, Res	asponse) 3 s or less (Nonvolatile mem ponse delay time: 20 ms or ponse delay time: 2 ms or l ponse delay time: 20 ms or onse delay time: 20 ms or l ponse delay time: 20 ms or l	00 µs (90 % response) ory (EEPROM) 1.5 s or less) less ess less ess *2
	Reset input Timing input Zero shift input Bank A input/Bank B input Laser emission stop input Ambient temperature	Input time: 20 ms or more In In In	10 µs (90 % re put time: 20 ms or more, Res ut time: 20 ms or more, Res put time: 2 ms or more, Res 10 to +50°C 14 to	asponse) 3 s or less (Nonvolatile mem ponse delay time: 20 ms or ponse delay time: 2 ms or l ponse delay time: 20 ms or onse delay time: 20 ms or l ponse delay time: 2 ms or l ponse delay time: 2 ms or l ponse delay time: 2 ms or l 122F° (No freezing)	00 µs (90 % response) ory (EEPROM) 1.5 s or less) less ess less ess *2
Environment	Reset input Timing input Zero shift input Bank A input/Bank B input Laser emission stop input Ambient temperature Ambient humidity	Input time: 20 ms or more In In In	10 µs (90 % re put time: 20 ms or more, Res ut time: 20 ms or more, Res put time: 2 ms or more, Res 10 to +50°C 14 to 35 to 85%RH (N	asponse) 3 Is or less (Nonvolatile mem ponse delay time: 20 ms or ponse delay time: 2 ms or l ponse delay time: 20 ms or onse delay time: 20 ms or l ponse delay time: 2 ms or l condensation)	00 µs (90 % response) ory (EEPROM) 1.5 s or less) less ess less ess *2 ess
Environment	Reset input Timing input Zero shift input Bank A input/Bank B input Laser emission stop input Ambient temperature Ambient humidity Vibration resistance	Input time: 20 ms or more In In In	10 µs (90 % re e, Response delay time: 120 m put time: 20 ms or more, Res nput time: 2 ms or more, Res put time: 20 ms or more, Res ut time: 20 ms or more, Res nput time: 2 ms or more, Res 10 to +50°C 14 to 35 to 85%RH (N	asponse) 3 s or less (Nonvolatile mem ponse delay time: 20 ms or ponse delay time: 2 ms or l ponse delay time: 20 ms or l ponse delay time: 20 ms or l ponse delay time: 2 ms or l ponse delay time: 2 ms or l ponse delay time: 2 ms or l toponse delay time: 3 ms or l toponse delay time: 2 ms or l toponse delay time: 3 ms or l toponse delay time: 3 ms or l toponse delay time: 20	00 µs (90 % response) ory (EEPROM) 1.5 s or less) less ess less ess *2 ess
Environment esistance	Reset input Timing input Zero shift input Bank A input/Bank B input Laser emission stop input Ambient temperature Ambient humidity	Input time: 20 ms or more in land in l	10 µs (90 % re e, Response delay time: 120 m put time: 20 ms or more, Res nput time: 2 ms or more, Res put time: 20 ms or more, Res tut time: 20 ms or more, Res nput time: 2 ms or more, Res nput time: 2 ms or more, Res -10 to +50°C 14 to 35 to 85%RH (N to 55 Hz Double amplitude 1.5	as or less (Nonvolatile mem ponse delay time: 20 ms or ponse delay time: 20 ms or ponse delay time: 20 ms or l ponse delay time: 20 ms or l ponse delay time: 20 ms or l ponse delay time: 2 ms or l 122F° (No freezing) o condensation) mm 0.06° XYZ each axis: 2	to µs (90 % response) tory (EEPROM) 1.5 s or less) less ess less ess *2 ess
Environment esistance	Reset input Timing input Zero shift input Bank A input/Bank B input Laser emission stop input Ambient temperature Ambient humidity Vibration resistance	Input time: 20 ms or more in land in l	10 µs (90 % re e, Response delay time: 120 m put time: 20 ms or more, Res nput time: 2 ms or more, Res put time: 20 ms or more, Res ut time: 20 ms or more, Res nput time: 2 ms or more, Res 10 to +50°C 14 to 35 to 85%RH (N	as or less (Nonvolatile mem ponse delay time: 20 ms or ponse delay time: 20 ms or ponse delay time: 20 ms or leading time: 20 ms or leadi	to µs (90 % response) tory (EEPROM) 1.5 s or less) less ess less ess *2 ess thours Cable: PVC
Input Environment resistance Material Supplied item	Reset input Timing input Zero shift input Bank A input/Bank B input Laser emission stop input Ambient temperature Ambient humidity Vibration resistance	Input time: 20 ms or more in land in l	10 µs (90 % re e, Response delay time: 120 m put time: 20 ms or more, Res nput time: 20 ms or more, Res put time: 20 ms or more, Res ut time: 20 ms or more, Res nput time: 2 ms or more, Res -10 to +50°C 14 to 35 to 85%RH (N 0 55 Hz Double amplitude 1.5	as or less (Nonvolatile mem ponse delay time: 20 ms or ponse delay time: 20 ms or ponse delay time: 20 ms or l ponse delay time: 20 ms or l 122F° (No freezing) o condensation) mm 0.06° XYZ each axis: 2 conate, Key top: Polyacetal, Main body × 1 Front Power supply and i Expansion cable (50 m	to µs (90 % response) tory (EEPROM) 1.5 s or less) less ess less ess *2 ess

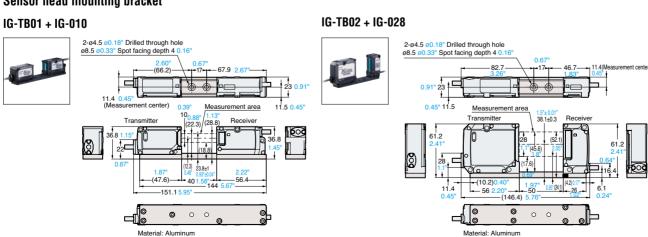
^{*1} When expansion units are added: Max. 20 mA/ch
*2 For more details, refer to the User's Manual.
*3 Delay time that occurs from the analog output circuit after the judgment is output.

Dimensions Unit: mm inch

Sensor head Transmitter Receiver IG-010 2-03.4 00 13 2-ø3.4 ø0.13" (Mounting hole) 1.02" Ø0.35 |---(26)---| Ø9 Measurement (Mounting hole) Transmission spot center 12.6 0.5" (26)-25.4 Ø4.8 Ø0.19" Cable length 170 6.6 Edge M8 connector -39.8 1.57" 0.26" 6.7 Ø4.8 Ø0.19" Cable length 170 6 Edge M8 connector -11.2 23.5___ 28.5 __ - 23 -23-- 55 * Light-receiving area (5 0.20" × 14 0.55" rectangle) * Transmission spot (reference value) 12-10.47 3-M3 Valid screw depth 4 3-M3 Valid screw depth 4 10.6 4.8 10.4 1.6 49.4 Base leve 2-M4 Valid screw depth 5.2 2-M4 Valid screw depth 5.2



Sensor head mounting bracket

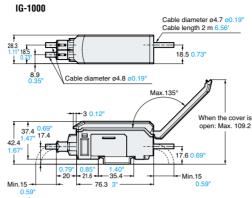


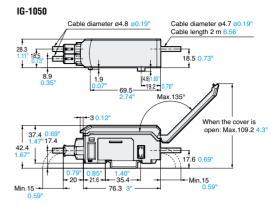
Unit : mm inch **Dimensions**

Sensor amplifier (DIN rail mount type)

IG-1000/IG-1050



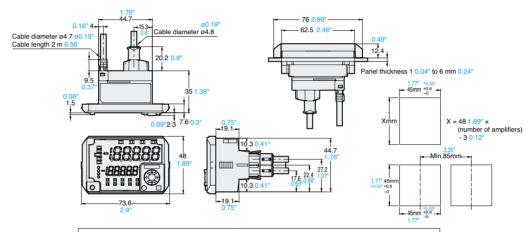




Sensor amplifier (Panel mount type)

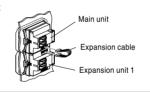
IG-1500/IG-1550





Notes on connecting a panel mount type expansion unit

Place the main unit in the top position, and bring the expansion unit into contact with the main unit vertically. For horizontal connection of the panel mount type, the optional expansion cable OP-35361 (300 mm) 11.8" type is required

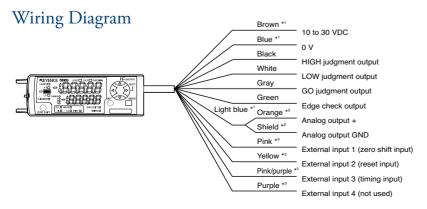


End unit (Optional) (2 pcs.)

OP-26751







- *1 The brown, blue, and light blue cables are not provided in a IG-1050/IG-1550 unit (expansion unit).
- The power is supplied to the expansion unit from the IG-1000/IG-1500 unit (main unit).

 *2 For an analog output, OFF (not used), 0 to 5 V, ±5 V, 1 to 5 V, or 4 to 20 mA can be selected.

 *3 For an external input, bank A input, bank B input, laser emission stop input, or OFF (not used) can also be selected.
- For external input 4, gain input can also be selected For details, refer to the User's Manual.

unication unit DI EC1A NEW

Ellicioni Nelwork communication unit DE-EOTA NEW				
Model		DL-EC1A		
EtherCAT®	Compatible functions	Process data object communication (cyclic communication)		
Specifications	Companible functions	Mailbox communication (message communication) CoE compatible		
	Conformance test	Complies with V2.0.42		

PROFINET Network communication unit DL-PN1

Model		DL-PN1
	Davisa tura	Data I/O Communication
	Device type	Record data Communication
PROFINET specifications	Number of connections	1
	Update time	2 to 512 ms
	GSDML Version	Ver. 2.3
	Conformance class	Conformance Class A
	Conformance test	V2.2.4
	Compliant protocol	LLDP, DCP

PROFIBUS DP Network communication unit DL-PD1

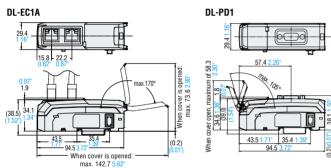
Model		DL-PD1
	Device type	DP-V1 Slave (D-sub 9 pin, Number of the ports: 1)
PROFIBUS	Communication speed	9.6 kbps to 12 Mbps
DP specifications	Cable length	9.6/19.2/45.45/93.75 kbps: 1200 m 3937.0' 187.5 kbps: 1000 m 3280.8', 500 kbps: 400 m 1312.3' 1.5 Mbps: 200 m 656.2', 3/6/12 Mbps: 100 m 328.1'

EtherNet/IP™ Network communication unit DL-EP1

Model		DL-EP1	
		Cyclic Communication	
	Compatible Functions	Message communication (Explicit messaging) Compatible with UCMM and Class 3	
EtherNet/IP™	Number of connections	64	
Specifications	RPI (Transmission cycle)	0.5 to 10000 ms (0.5 ms unit)	
	Tolerable communication bandwidth for cyclic communication	6000 pps	
	Conformance Test	Compatible with Version A7	

Dimensions

Unit: mm inch



DeviceNet™ Network communication unit DL-DN1

Model		DL-DN1			
	Compatible functions	Input/Output communication (poll)/Explicit Message Communication			
	Address Settings		0 to 63 (PGM compatible)		
DeviceNet™ Chapifications	Communication speed (Automatic switching method)	500 kbps	250 kbps	125 kbps	
Specifications	Maximum cable	100 m 328.1' (thick cable)	250 m 820.2' (thick cable)	500 m 1640.4' (thick cable)	
	length	100 m 328.1' (thin cable)	100 m 328.1' (thin cable)	100 m 328.1' (thin cable)	
	Network power source	11 to 25 VDC (DeviceNet™ provided from the communication power source)			

CC-Link Network communication unit DL-CL1

Model		DL-CL1
CC-Link specifications	Compatible versions	Ver. 2.00/Ver. 1.10 (selectable)
	Number of occupied stations	Ver. 2.00: 1 station, 8×/2 stations, 8×/4 stations, 2×; (selectable) Ver. 1.10: 1/2/4 stations (selectable)
	Type of station	Remote device station
	Transmission rate	156 kbps/625 kbps/2.5 Mbps/5 Mbps/10 Mbps
	Setting of station numbers	1 to 64

TCP/IP Network communication unit DL-EN1 NEW

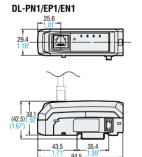
Model		DL-EN1
Ethernet Specifications	Transmission rate	100 Mbps (100BASE-TX)
	Transmission medium	STP cable or Category 5 or higher UTP cable (100BASE-TX)
	Maximum cable length	100 m 328.1' (Distance between DL-EN1 and Ethernet switch)
Performance specifications	Socket communication, no-protocol commands, ASCII	TCP socket 1

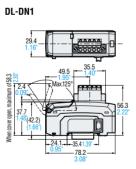
RS-232C Network communication unit DL-RS1A

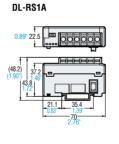
Model		DL-R\$1A
RS-232C Specifications	Communication Method	Full duplex
	Synchronization Method	Start-stop
	Transmission Code	ASCII
	Baud rate	2400/4800/9600/19200/38400 bps

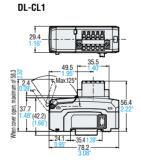
BCD Network communication unit DL-RB1A

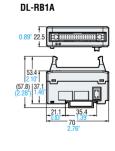
Model		DL-RB1A
BCD Output Specifications	Input/Output Terminal	34 pin connector (MIL Standard)
	Control Output	BCD Output: 4 (1 column) × 6 columns, signal output, strobe output, alarm output NPN Open collector 40 V, 20 mA or less, residual voltage 1 V or less Positive logic/Negative logic can be switched
	Control Input	ID Selection Input: 4, data request input Non-voltage input, input time 2 ms or more, short circuit current 1 mA













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